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Stabilization of reduced copper on ceria aerogels for CO oxidation†

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Photodeposition of Cu nanoparticles on ceria (CeO₂) aerogels generates a high surface area composite material with sufficient metallic Cu to exhibit an air-stable surface plasmon resonance. We show that balancing the surface area of the aerogel support with the Cu weight loading is a critical factor in retaining stable Cu⁰. At higher Cu weight loadings or with a lower support surface area, Cu aggregation is observed by scanning and transmission electron microscopy. Analysis of Cu/CeO₂ using X-ray photoelectron spectroscopy and Fourier-transform infrared spectroscopy finds a mixture of Cu²⁺, Cu⁺, and Cu⁰, with Cu⁺ at the surface. At 5 wt% Cu, Cu/CeO₂ aerogels exhibit high activity for heterogeneous CO oxidation catalysis at low temperatures (94% conversion of CO at 150 °C), substantially outperforming Cu/TiO₂ aerogel catalysts featuring the same weight loading of Cu on TiO₂ (20% conversion of CO at 150 °C). The present study demonstrates an extension of our previous concept of stabilizing catalytic Cu nanoparticles in low oxidation states on reducing, high surface area aerogel supports. Changing the reducing power of the support modulates the catalytic activity of mixed-valent Cu nanoparticles and metal oxide support.

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1. Introduction

Stabilizing reduced copper nanoparticles (Cu NPs) under ambient conditions is desirable for catalytic applications where low-valent Cu is more active than CuO and for plasmonic applications as a nonprecious alternative to Au and Ag. One way to achieve low-valent Cu is through interaction with reducing oxide supports. Well-engineered materials favor Cu₂O over the more prevalent but less active CuO.^{1,2} Extending this concept, Vovchok *et al.* reported reduction of Cu²⁺ to Cu⁰ on their microporous cerium oxide (CeO₂) support at elevated temperature under *operando* conditions, but did not discuss whether sufficient Cu⁰ was stabilized to produce surface plasmon resonance (SPR).³ We are aware of only two reports of nanoscale Cu supported on CeO₂ that demonstrate SPR.^{4,5}

We recently reported stable metallic Cu⁰ and Cu⁺ content in Cu NPs photodeposited from Cu²⁺ salts on titania aerogels (Cu/TiO₂(aero)).⁶ We attribute the stability of low-valent Cu to a close interaction between the oxide support and the deposited Cu NPs, made possible by the high surface area and small particle size of the oxide support. Donation of electron density from the reducing oxide to the supported metal NP stabilizes sufficient metallic Cu for Cu/TiO₂(aero) to exhibit a Cu SPR.⁶ In contrast, Cu photodeposition on larger diameter, low surface-area particulate TiO₂ (Cu/TiO₂(partic)) does not produce materials that exhibit a SPR. The importance of the morphology of TiO₂ in supporting a Cu SPR calls into question whether (1) other reducible metal oxides will display the same stabilization of low-valent Cu and (2) if similar morphology constraints are required when employing a more easily reducible metal oxide.

Copper NPs on CeO₂ supports are extensively studied catalysts for CO oxidation,^{7–10} the water–gas shift reaction,^{11–13} and volatile organic compound oxidation.^{14,15} A complicating factor is that CeO₂ is active on its own due to facile Ce^{4+/3+} redox interchange allowing the material to act as an oxygen buffer.¹⁶ This reducibility is a key feature of CeO₂ catalytic cycles.

The reducibility of the metal oxide is further increased by nanostructuring the support. The formation energy of a corner oxygen vacancy in small CeO₂ clusters is calculated to be as low as 0.8 eV in comparison to the 2.25 eV calculated on the extended (111) surface, the most thermodynamically stable facet of fluorite CeO₂.¹⁷ This effect is attributed to the presence

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of under-coordinated surface sites in nanostructured supports as well as the flexibility of nanoparticles to relax around oxygen vacancies and thereby stabilize them.¹⁸ Several groups have focused on developing nanostructured CeO₂ supports to produce highly defective materials, including by controlling the shape of the nanoparticles,^{7,8} template syntheses,¹⁹ and using specific calcination protocols.⁹ The addition of supported metal nanoparticles can increase the reducibility of the support by providing an electron sink to stabilize the charge produced by oxygen-vacancy generation.¹⁸ In addition to altering the reducibility of the oxide, deposition also introduces Cu||CeO₂ interfaces that are implicated in reactivity.²⁰ The aerogel expression of the reducing oxide offers critical attributes: increased reducibility of the support through nanostructuring and more oxide NP||Cu NP junctions.

We now show that another reducible metal oxide aerogel stabilizes metallic Cu. Using CeO₂, a reducible metal oxide amenable to aerogel synthesis, we report herein that Cu/CeO₂ aerogel stabilizes a significant fraction of reduced Cu species (Cu⁰ and Cu⁺) in the Cu nanoparticles. Furthermore, copper nanoparticle-modified ceria aerogel exhibits an SPR and demonstrates high activity for the low-temperature heterogeneous catalytic oxidation of carbon monoxide (CO).

2. Results and discussion

2.1 Synthesis of Cu/CeO₂ materials

The ceria aerogel (CeO₂(aero)) is prepared following literature procedures for sol-gel synthesis and then supercritically drying the wet gel.²¹ The gel is formed by epoxide-driven hydrolysis of CeCl₃ in methanol. After forming dispersed CeO₂ particles (the “sol”), the hydrolysis continues to covalently crosslink the oxide nanoparticles to form a gel. The aged gel is rinsed with isopropanol and acetone, and then the acetone-filled gel is dried with supercritical CO₂ to produce an amorphous CeO₂(aero). The aerogel is calcined in static air at 500 °C for 2 h (5 °C min⁻¹ heating and cooling ramp) to crystallize the networked CeO₂ domains. Post-calcination, CeO₂(aero) has an average of 82(11) m² g⁻¹ surface area, 0.35(7) cm³ g⁻¹ pore volume, and 17(3) nm average pore diameter (Table S1, Fig. S1 and S2†). As is typical for sol-gel syntheses, slight variation occurs between nominally identical batches of the aerogel support; we report

values that are an average of 7 replicate batches. The fluorite crystal structure expected for CeO₂ after calcination at 500 °C is confirmed using powder X-ray diffraction (XRD). Scherrer analysis estimates 6–9 nm diameter crystallites from the (111) reflection at $2\theta = 28.55^\circ$ (Fig. S3†), with the range reflecting batch-to-batch variation, in good agreement with the highly textured morphology seen by scanning electron microscopy (SEM, Fig. 1).

In order to determine the effects of the aerogel morphology on the properties of the CeO₂ support, we examined a commercially obtained particulate nanopowder ceria (CeO₂(partic)). The commercial CeO₂ has lower surface area (26 m² g⁻¹ vs. 82(11) m² g⁻¹) and pore volume (0.09 cm³ g⁻¹ vs. 0.35(7) cm³ g⁻¹) than the aerogel and lacks the covalent bonding between CeO₂ nanoparticles present in the aerogel network. Crystalline regions averaged 21(1) nm diameter by XRD, suggesting particulate CeO₂ is 2–3 times larger than the bonded CeO₂ nanoparticles in the aerogel network. By SEM, particles as large as 75 nm across are observed (Fig. 1), which may comprise several crystalline domains or reflect the size range of crystallites in CeO₂(partic).

Ceria has a direct band gap with an energy (E_g) that depends on crystallite size;²² the energies for CeO₂(aero) and CeO₂(partic) are calculated from Tauc plots of the diffuse-reflectance UV-Vis spectra (Fig. S4†). The values are 2.95 eV (420 nm) and 3.08 eV (403 nm) for CeO₂(aero) and CeO₂(partic), respectively. Although the CeO₂(aero) crystallite size is less than the CeO₂ Bohr radius (7–9 nm) and quantum confinement has been observed for dispersed CeO₂ nanoparticles,²³ the covalent attachment of the CeO₂ crystallites in the aerogel framework likely prevents confinement. Indeed, the opposite effect is instead observed, with CeO₂(aero) showing a decrease in bandgap energy compared to bulk CeO₂ (3.19 eV, 389 nm). This red-shift was previously observed and attributed to the presence of surface Ce ions (in either the 4+ or 3+ oxidation states) and the presence of oxygen vacancies.²⁴ The red-shift of the bandgap energy for CeO₂(aero) relative to CeO₂(partic) is consistent with this interpretation, given the smaller size of the crystallites and higher surface area of the aerogel.

Copper nanoparticles are photodeposited using a modification of the procedure described by Wu *et al.*²⁵ A slurry of ethanol, water, ceria, and copper(II) nitrate at pH 9–10 is stirred

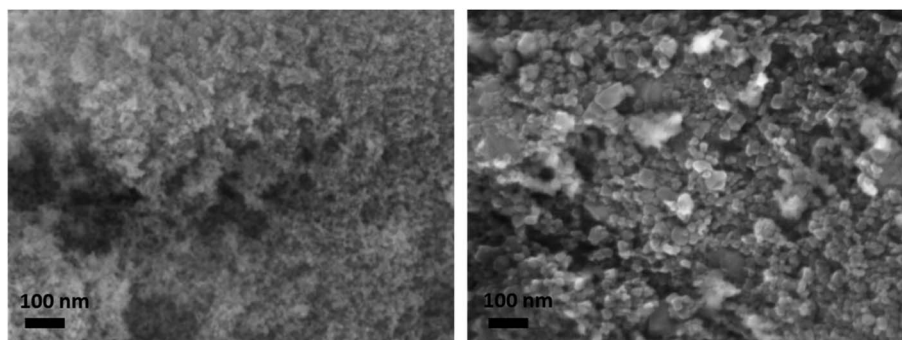


Fig. 1 Scanning electron micrographs of (left) CeO₂(aero) and (right) CeO₂(partic).



under inert atmosphere while irradiating with broadband light, adjusting the ratio of Ce : Cu to achieve a nominal 2.5–10 wt% copper loading. Excitation of the CeO₂ band gap leads to mobile electrons that can reduce Cu²⁺ adsorbed on the surface. Charge compensation is provided by oxidation of a sacrificial reagent (ethanol). To maintain the large surface area of the CeO₂ support, gentle drying techniques are needed following photodeposition. When samples dried at ambient conditions are heated under vacuum, pore collapse is observed. To minimize this deleterious loss of pore volume, after collecting the solids from the photodeposition on a membrane filter, the material is first dried at ambient conditions overnight, and then dried at 70 °C for 24 h. Porosimetry of materials dried in this manner do not reveal pore collapse, although a small reduction in pore diameter occurs, consistent with partial filling of pores by Cu NPs (Fig. 2A).

Copper weight loading is assessed by X-ray fluorescence spectroscopy, comparing Cu : Ce fluorescence intensity to a standard curve of physically mixed CuO and CeO₂ (both averaging <50 nm diameter particles). Copper weight loadings closely approximate the nominal weight loading (Table 1). Nominally 5 wt% Cu/CeO₂ aerogel (5Cu/CeO₂(aero)) has between 5.4–5.8 wt% Cu, while nominally 5 wt% Cu/CeO₂ particulate (5Cu/CeO₂(partic)) has 4.8–4.9 wt% Cu. The

nominally 2.5 wt% and 10 wt% Cu/CeO₂ aerogels ((2.5Cu/CeO₂(-aero) and 10Cu/CeO₂(aero)), respectively) are 2.8 wt% and 10.5 wt% Cu, respectively. Following deposition, CeO₂ maintains its fluorite structure, but no Cu reflections are observed at either 2.5 wt% or 5 wt% Cu loading (Fig. 2B). For 10Cu/CeO₂(aero), reflections for CuO, but not Cu₂O or Cu(0), are observed by XRD (Fig. S5†).

For microstructural characterization, both scanning transmission electron microscopy with high-angle annular dark-field (STEM-HAADF) imaging as well as conventional high-resolution transmission electron microscopy (HR-TEM) imaging were performed, as seen in Fig. 3A–C. These analyses show the ceria support to be extended aerogel structures with crystallites ~5–15 nm in size and a CeO₂(111) lattice spacing of 0.31 nm, comparable to the values found by XRD. The high atomic number (Z) of Ce compared to Cu precludes an intensity-based identification and imaging of Cu NPs.

For compositional analysis, we relied on energy-dispersive spectroscopy (EDS) and electron energy-loss spectroscopy (EELS) (Fig. 3D–F). The EDS-measured composition (2% copper by weight) was similar to that obtained by XRF. Acquiring an unambiguous image of the Cu nanoparticle morphology was elusive—neither EDS nor EELS show significant enough signal above the Ce background that is localized to ‘nanoparticle’-type

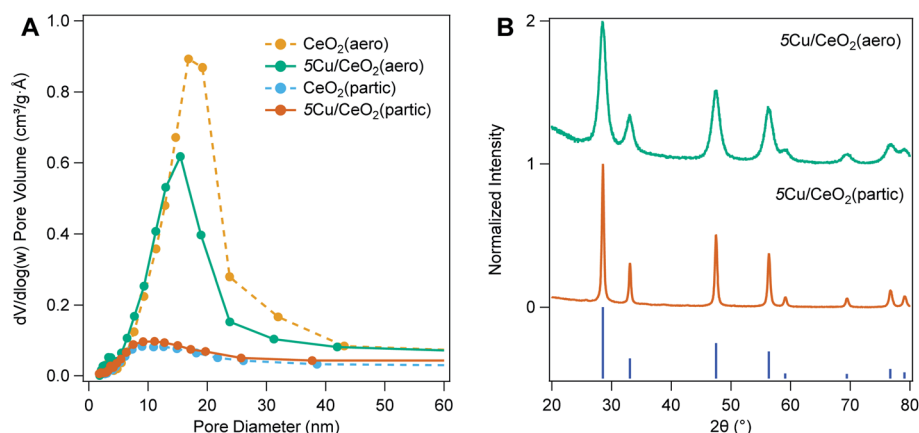


Fig. 2 (A) Differential pore volume as a function of pore width for CeO₂(aero) and CeO₂(partic) with and without photodeposited copper. (B) Representative X-ray diffraction patterns of 5Cu/CeO₂(aero) and 5Cu/CeO₂(partic) materials compared to CeO₂ (JCPDS# 01-089-8436). Scherrer analysis of the CeO₂ (111) reflection at $2\theta = 28.55^\circ$ with FWHM of $1.28(1)^\circ$ and $0.38(1)^\circ$ gives 6.3(1) nm and 21.3(6) nm CeO₂ particles for 5Cu/CeO₂(aero) and 5Cu/CeO₂(partic), respectively.

Table 1 Physical characterization of CeO₂ aerogel and particulate supports before and after photodeposition of Cu

Sample	CeO ₂ diameter ^a (nm)	% Cu ^b	% Cu ^{0,+c}	Surface area ^d (m ² g ⁻¹)	Pore volume ^d (cm ³ g ⁻¹)	Pore width ^d (nm)
CeO ₂ (aero)	8.8(14)	—	—	79	0.35	15.7
2.5Cu/CeO ₂ (aero)	8.8(14)	2.8	44(10)	82	0.28	11.2
5Cu/CeO ₂ (aero)	8.8(14)	5.6	50(19)	83	0.30	13.0
10Cu/CeO ₂ (aero)	8.8(14)	10.5	42(10)	65	0.27	11.8
CeO ₂ (partic)	21.3(6)	—	—	26	0.08	12.0
5Cu/CeO ₂ (partic)	21.3(6)	4.8	30(10)	31	0.11	12.6

^a Determined *via* XRD, calculated across all aerogel or particulate samples. ^b Determined *via* XRF. ^c Determined *via* XPS. ^d Determined *via* desorption arm of nitrogen physisorption.



morphologies. Additional transmission electron micrographs are found in the ESI.†

2.2 Influence of support surface area and mesostructure on electronic state of Cu

The diffuse reflectance UV-visible spectra of 5Cu/CeO₂(aero) and 2.5Cu/CeO₂(aero) (Fig. 4A and B), prepared with 48 h of irradiation, both exhibit a broad feature at 740 nm consistent with Cu SPR.⁶ Irradiation of 5Cu/CeO₂(partic) did not produce an SPR, despite using the same photodeposition conditions, and instead displayed features consistent with CuO and Cu₂O.⁶ At a higher weight loading, even 96 h of photoreduction does

not produce a visible SPR for 10Cu/CeO₂(aero). In contrast, 10Cu/TiO₂(aero) exhibits a Cu SPR feature after only 24 h of photoreduction. Theoretical work predicts that the presence of a Cu SPR suggests that the Cu NPs are at least 2 nm in diameter.²⁶

When comparing Cu SPRs produced at 5 wt% Cu supported on the two metal oxide aerogels, the intensity of the SPR is brighter on TiO₂ than on CeO₂ (Fig. 4C), suggesting more metallic Cu is stabilized on TiO₂(aero) than CeO₂(aero). Notably, there is a higher absorbance between 400 nm and 600 nm on 5Cu/CeO₂(aero) relative to 5Cu/TiO₂(aero), which may be an indication of more Cu⁺ on CeO₂ due to the band-gap adsorption of Cu₂O at ~580 nm.²⁷

Ceria appears less able than TiO₂ to support metallic copper given that (1) longer irradiation times are required to produce SPRs, (2) the SPR response is not as bright on CeO₂ relative to TiO₂, and (3) an SPR is not observed on CeO₂ aerogels at ≥5 wt% Cu. As the ratio of Cu to CeO₂ surface area increases, either by increasing the copper loading or by decreasing the surface area of the support, SPRs are not observed. Rather, we observe large Cu features in the SEM suggesting that the available sites for Cu nucleation have been exhausted, and that further Cu deposition results in particle growth (Fig. S11–S13†). These large copper particulates interact less extensively with the CeO₂ support (have a lower ratio of interface to bulk volume), which is consistent with their oxidized state.

On a per mass basis, CeO₂ has less available surface area (~80 m² g⁻¹) than TiO₂ (~150 m² g⁻¹) to support a given weight loading of Cu NPs. On a per mole basis, however, the surface area of the two metal oxide aerogels is comparable (14 000 m² (mol CeO₂)⁻¹ to 12 000 m² (mol TiO₂)⁻¹). The disparity in atomic weight is highlighted by the fact that 10Cu/TiO₂(aero) and 5Cu/CeO₂(aero) both support 12 mol% Cu while 10Cu/CeO₂(aero) supports 23 mol% Cu. Surface area and available nucleation sites are clearly important considerations as to whether or not the photodeposited material can support a Cu SPR. Further illustrating this surface-area dependence, when nanoparticulate supports rather than aerogel supports of either oxide are utilized, the SPR feature is absent.

In addition to surface-area effects, we use X-ray photoelectron spectroscopy (XPS) to assess if differences in the Ce⁴⁺ : Ce³⁺ ratio in the aerogel and nanoparticulate supports contribute to the differences in speciation of supported Cu NPs. In the Ce 3d region (Fig. 5A, 875 to 925 eV), the Ce⁴⁺ signature consists of 6 peaks between 882.6 eV and 916.7 eV while Ce³⁺ gives rise to 4 peaks between 880.6 eV and 904.1 eV.²⁸ Recently published results have shown that with these 10 peaks in the Ce 3d region, small modifications to the peak-fitting procedure can vary the estimated Ce³⁺ content from 2.3% to 38.9%.²⁹ Given the similarity of the Ce peaks in our particulate and aerogel samples, we have elected to not fit this region and qualitatively assert that, at least under vacuum conditions, both supports are dominated by Ce⁴⁺ and have similar Ce³⁺ content. The similarity in Ce³⁺ content suggests that the differences in Cu speciation that we observe are due more to the surface area and morphology of the support than to their degree of reducibility.

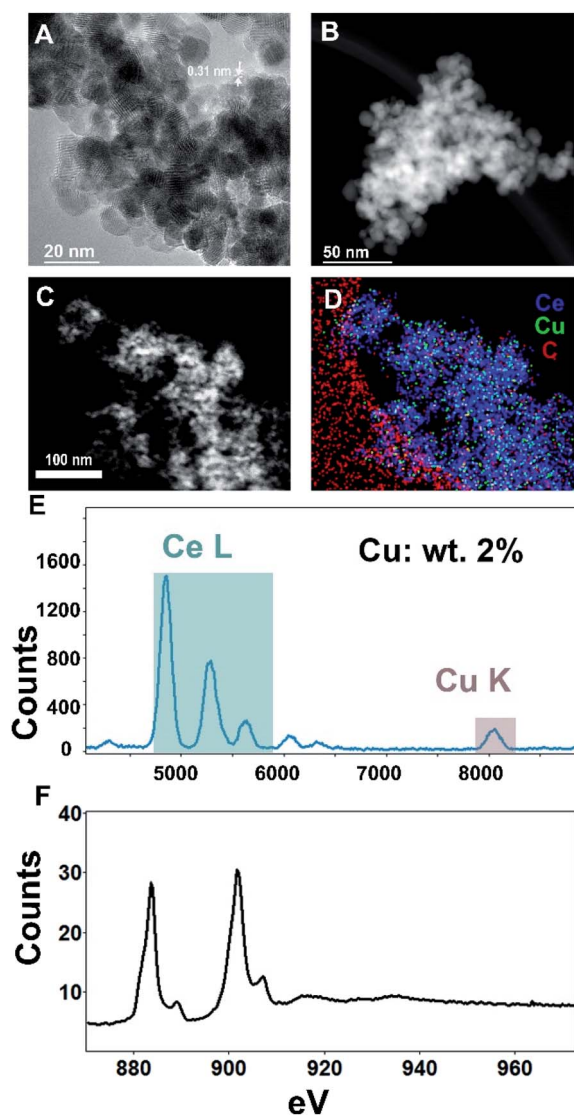


Fig. 3 Transmission electron microscopy (TEM) of copper nanoparticles supported on 5Cu/CeO₂(aero). (A) High-resolution (HR-TEM) of 5Cu/CeO₂(aero). (B) High-angle annular dark-field image in scanning mode (STEM-HAADF). (C) STEM-HAADF image corresponding with (D) energy-dispersive spectroscopy in scanning mode (STEM-EDS). (E) EDS plot of broad-beam irradiated 5Cu/CeO₂(aero) showing Ce and Cu present. (F) Electron energy-loss-spectroscopy of broad-beam irradiated 5Cu/CeO₂(aero).



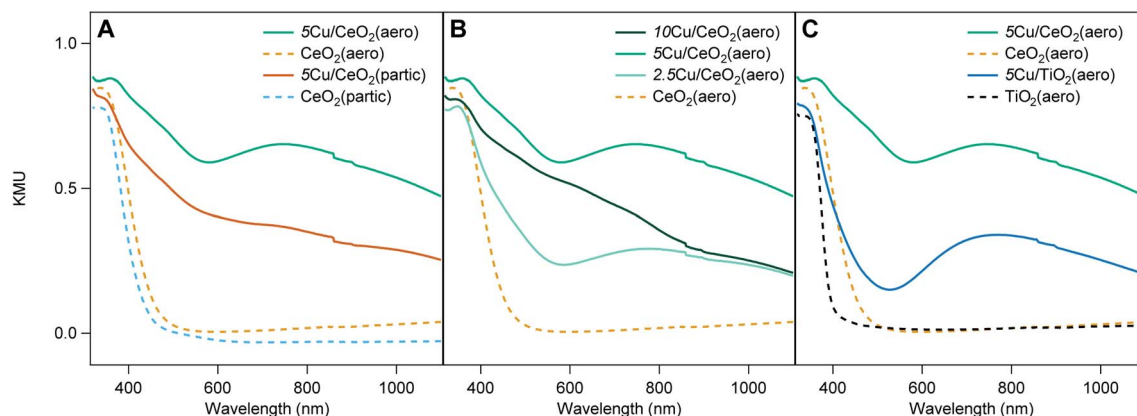


Fig. 4 Diffuse reflectance UV-Vis spectra in Kubelka-Munk units (KMU) for (A) 5Cu/CeO₂(aero) (green), CeO₂(aero) (dashed yellow), 5Cu/CeO₂(partic) (amber), and CeO₂(partic) (dashed blue); (B) 10Cu/CeO₂(aero) (dark green), 5Cu/CeO₂(aero) (green), 2.5Cu/CeO₂(aero) (light green), and CeO₂(aero) (dashed yellow); (C) 5Cu/CeO₂(aero) (green), 5Cu/TiO₂(aero) (blue), CeO₂(aero) (dashed yellow), and TiO₂(aero) (dashed black).

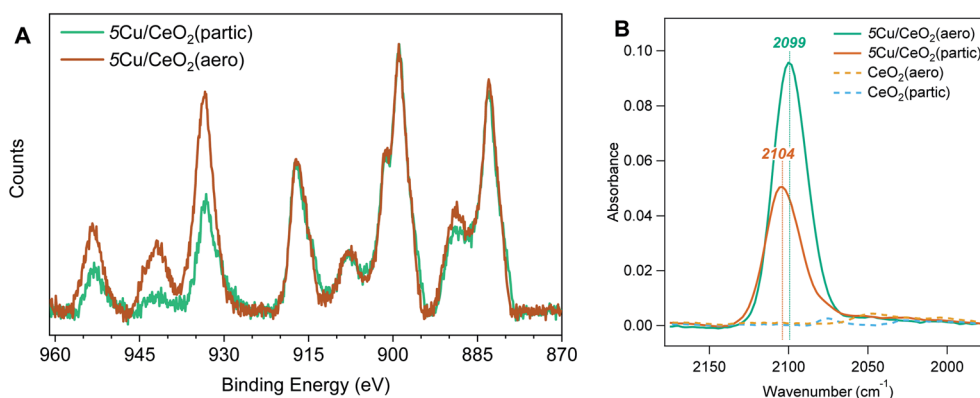


Fig. 5 (A) Background-subtracted X-ray photoelectron spectra of 5Cu/CeO₂(partic) (amber) and 5Cu/CeO₂(aero) (green) in the Ce 3d (875 to 925 eV) and Cu 2p (925 to 965 eV) regions. (B) ATR-FTIR spectra for 5Cu/CeO₂(aero) (green), 5Cu/CeO₂(partic) (amber), CeO₂(aero) (dashed yellow), and CeO₂(partic) (dashed blue), showing CO binding at 2099 cm⁻¹ and 2104 cm⁻¹ for 5Cu/CeO₂(aero) and 5Cu/CeO₂(partic), respectively.

The differences in Cu speciation between 5Cu/CeO₂(aero) and 5Cu/CeO₂(partic) are apparent in the Cu 2p region of the XPS spectra (Fig. 5A, 925 to 965 eV). The Cu 2p_{3/2} region consists of a peak at 932 eV for Cu⁰ and Cu⁺, low-valent states indistinguishable in these spectra, and a peak at 934 eV for Cu²⁺. Notably, Cu²⁺ gives rise to a shake-up feature around 941 eV, which is more prominent for 5Cu/CeO₂(partic) than 5Cu/CeO₂(aero). We attempted to resolve Cu⁰ and Cu⁺ by fitting the Auger CuLMM line; however, given the mixture of oxidation states, peak broadening inherent to insulating materials, and low Cu content of our catalysts, satisfactory fits were not obtained (Fig. S14†).

To quantify the proportion of reduced Cu in these materials (Cu⁰ and Cu⁺), we use the method described by Biesinger to compare the area under the 2p_{3/2} and shake-up features.³⁰ The advantage of this method is that it is insensitive to peak broadening caused by surface charging and peak shifts expected for Cu particles of different sizes on supports.³¹ We find a higher percentage of reduced Cu for 5Cu/CeO₂(aero) (50 ±

19%) than for 5Cu/CeO₂(partic) (30 ± 10%), which is consistent with the presence of an SPR on the aerogel and lack of an SPR on the particulate. For 5Cu/TiO₂(aero) this method gives 30% reduced Cu, which given the prominence of the SPR, suggests that the reduced Cu is predominantly metallic. In contrast, given its lack of an SPR, the 30% reduced Cu content in 5Cu/CeO₂(partic) is likely Cu⁺. The signal intensity of Cu (relative to Ce) for 5Cu/CeO₂(partic) is also higher than for 5Cu/CeO₂(aero), despite XRF confirming similar Cu loadings. This difference is expected for a support with lower surface area. XPS is a surface-sensitive technique, and a larger fraction of the surface of the low surface-area particulate is covered with Cu at the same mass loading as on the high surface-area aerogel. We observed a similar overestimation by XPS of Cu loading on TiO₂(partic) supports, which have a surface area of 10 m² g⁻¹.³²

We utilize CO as a probe molecule in attenuated total reflectance Fourier transform infrared (ATR-FTIR) spectroscopy to interrogate the morphology and electronic structure of the photodeposited Cu. Binding modes are observed at 2099 cm⁻¹ and



2104 cm^{-1} for 5Cu/CeO₂(aero) and 5Cu/CeO₂(partic), respectively, on 4 mg films cast on ZnSe ATR crystals under CO flow (Fig. 5B). These positions are consistent with the reported binding energy for CO on Cu⁺ sites. Stacchiola *et al.* reported a peak at 2097 cm^{-1} , which they attributed to small islands of Cu₂O on metallic Cu surfaces, and saw this mode blue-shift to 2114 cm^{-1} as CeO₂ coverage of their Cu substrate increased.³³ Both peaks are assigned to formally Cu⁺ species, where increasing contact with CeO₂ withdraws electron density from Cu⁺, which reduces back-donation to bound carbonyl, and thus results in a stronger C–O bond. The weaker carbonyl stretch observed on 5Cu/CeO₂(aero) (2099 cm^{-1}) is consistent with subsurface metallic Cu underlying Cu⁺, as is suggested by the presence of a Cu SPR. The stronger carbonyl stretch observed on 5Cu/CeO₂(partic) (2104 cm^{-1}) shows that this Cu⁺ is in a less reducing environment, as is expected for a material that shows no Cu SPR and a lower fraction of reduced Cu by XPS. The smaller peak intensity on the particulate support derives from less accessible Cu surface area and larger Cu particles, as substantiated by the large Cu features observed in SEM and TEM.

At ambient temperature, no features associated with Ce⁴⁺–CO (2168 cm^{-1}), Ce³⁺–CO (2161 cm^{-1}), or Cu⁰–CO (2073 cm^{-1})^{33,34} are observed on any of the materials studied. Carbonyl association on these sites is expected to be weak, and typically, low temperatures are required for their observation.³⁴

2.3 Thermal CO oxidation

We next examine the effect of reducible CeO₂(aero) mesoporous metal oxide support on the catalytic activity of Cu NPs for CO oxidation. Catalyst beds are pre-treated at 150 °C in 64 mL min^{−1} of an anoxic flow (0.8 mL min^{−1} CO, 63 mL min^{−1} He). After activation, O₂ is added into the feed stream (16 mL min^{−1}), and CO consumption and CO₂ production are monitored by an in-line GC. We choose the modest activation temperature to compare to our earlier work on TiO₂ and to minimize Cu particle ripening.^{32,35–37}

After activation, catalyst beds of CeO₂(aero) show no activity for CO oxidation below 150 °C (Fig. S15†). The commercial CeO₂(partic) shows slightly more activity than CeO₂(aero), achieving a maximum of 15% CO conversion at 150 °C. Duplicate beds packed using catalyst from the same batch show minimal difference in activity indicating that preparation of the catalyst bed has negligible impact. Thermogravimetric analysis does not show substantial weight loss indicating that surface-adsorbed species also have a negligible impact on catalysis (Fig. S16†). Activity is consistent over multiple regeneration cycles of the bare CeO₂(aero) while a small loss is observed after the first regeneration of the CeO₂(partic) material (Fig. S17†). The bare supports are used as diluent in the catalyst bed of Cu/CeO₂ samples, and this lack of reactivity confirms that the diluent in the catalyst bed is a minor contributor to CO oxidation.

With the addition of 5Cu/CeO₂(aero) into the catalyst bed (10 mg of catalyst to 40 mg of Cu-free CeO₂(aero)), at 150 °C, 94% conversion of CO is observed (3.5 mol_{CO} min^{−1} mol_{Cu}^{−1}). Conversion falls as the temperature is decreased, reaching 50% conversion (*T*₅₀) at 91 °C (Table 2) and falling to 0.5%

conversion at the lowest temperature for which we recorded data: 50 °C. The catalyst is regenerated using the same method as the activation. Upon regeneration, minimal difference in activity from the fresh bed (Fig. 6B) indicates that the catalyst is stable and not likely undergoing significant, irreversible changes during the course of the reaction.³² The catalyst is stable over four regenerations (5 cycles), lasting a total of 27.5 h on stream. At the same weight loading, the CO oxidation activity of 5Cu/CeO₂(aero) far exceeds that of 5Cu/CeO₂(partic) (10 mg of catalyst, 40 mg of CeO₂(partic)), presumably due to the higher surface area of the aerogel and the more reduced Cu it supports.

We compare the effect of Cu weight loadings on CeO₂(aero) for the extent of CO conversion (Fig. 6C). Although 5Cu/CeO₂(aero) shows higher CO conversion than 2.5Cu/CeO₂(aero), on a Cu-normalized basis, the lower weight loading material is more active (4.7 mol_{CO} min^{−1} mol_{Cu}^{−1}). Increasing the weight loading to 10 wt% did not impact CO conversion, so the Cu-normalized conversion falls (1.7 mol_{CO} min^{−1} mol_{Cu}^{−1}). The Cu deposited for 10Cu/CeO₂(aero) beyond that deposited for 5 wt% does not contribute to CO oxidation, likely because the additional Cu is mostly oxidized and contained in the large “bicone” structures observed by SEM (Fig. S11†). The large, oxidized Cu regions in 10Cu/CeO₂(aero) are evidenced by the lack of an SPR in its absorption spectrum (Fig. 4B) and by the prominent CuO reflections in its XRD pattern (Fig. S5†).

We also contrast the activity of Cu/CeO₂ catalysts to both 5Cu/TiO₂(aero) and 10Cu/TiO₂(aero) catalysts (Fig. 6D). For TiO₂-based samples, the catalyst bed comprises 10 mg of active material diluted with 40 mg of TiO₂(aero) (and similarly the diluent is a negligible contributor to CO oxidation activity). The pretreatment and data collection procedures are identical to those of the Cu/CeO₂ materials. We find little activity for CO conversion with our 5Cu/TiO₂(aero): 20% at 150 °C (0.8 mol_{CO} min^{−1} mol_{Cu}^{−1}) and negligible conversion below 100 °C. The 10Cu/TiO₂(aero), the subject of our previous study,³² had a conversion of about 90% at 150 °C (1.9 mol_{CO} min^{−1} mol_{Cu}^{−1}), but conversion decreased rapidly, falling to below 50% conversion at 120 °C.

The reduction in activity upon halving the Cu weight loading on TiO₂ was much more severe than the modest reduction in CO conversion observed for Cu/CeO₂(aero). This reduction in activity on TiO₂ may suggest that Cu⁰ and Cu⁺, which are expected to be the primary drivers of CO oxidation, may be

Table 2 Kinetics data for CO oxidation over Cu/CeO₂ in a packed bed reactor

Sample	mol _{CO} min ^{−1} mol _{Cu} ^{−1} at 150 °C	X _{CO} at 150 °C	<i>T</i> ₅₀ (°C)
CeO ₂ (aero)	—	0.03	—
CeO ₂ (partic)	—	0.15	—
5Cu/CeO ₂ (partic)	2.4	0.55	144
2.5Cu/CeO ₂ (aero)	4.7	0.64	119
5Cu/CeO ₂ (aero)	3.5	0.94	91
10Cu/CeO ₂ (aero)	1.7	0.88	91
5Cu/TiO ₂ (aero)	0.8	0.20	—
10Cu/TiO ₂ (aero)	1.9	0.90	120



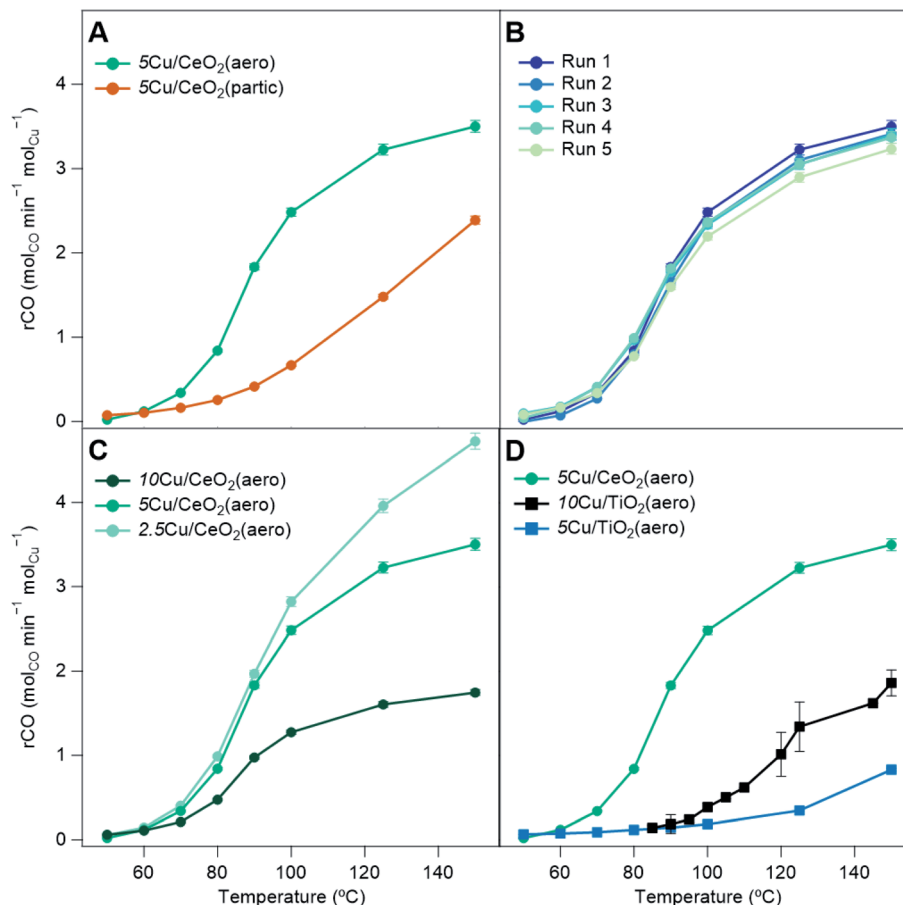


Fig. 6 CO conversion as a fraction of mol CO converted per min per mol Cu in catalyst bed versus temperature for (A) catalysts with different CeO₂ supports: 5Cu/CeO₂(aero) (green) and 5Cu/CeO₂(partic) (amber); (B) 5 runs of 5Cu/CeO₂(aero) separated by regeneration of the catalyst bed; (C) different weight loading of Cu on CeO₂(aero): 10Cu/CeO₂(aero) (dark green), 5Cu/CeO₂(aero) (green), 2.5Cu/CeO₂(aero) (light green); and (D) catalysts with CeO₂ vs. TiO₂ supports: 5Cu/CeO₂(aero) (green), 5Cu/TiO₂(aero) (blue), 10Cu/TiO₂(aero) (black).

inaccessible or that Cu particles do not contain the appropriate synergistic mixture of Cu⁰ and Cu⁺ to aid in turnover.

Despite having lower surface area and lower Cu weight loading, 5Cu/CeO₂(aero) shows higher CO conversion than 10Cu/TiO₂(aero). When photodepositing Cu, sufficient surface area is required to prevent the formation of Cu aggregates and to ensure the extended interaction between the metal oxide support and the Cu NPs. But with this surface area requirement met in both 5Cu/CeO₂(aero) and 10Cu/TiO₂(aero), the superior CO oxidation activity shown on the CeO₂(aero) supports at a lower Cu weight loading is likely due to the increased reducibility of CeO₂. The increased reducibility of CeO₂ facilitates generation of oxygen vacancies that activate molecular O₂.^{16–18} Activated oxygen species react with CO bound to Cu⁺ sites located near the oxide interface²⁰ to facilitate CO₂ generation.

3. Conclusions

We show that reduced Cu NPs displaying SPRs are supported on high surface-area CeO₂ aerogel, similar to our prior report for Cu supported on TiO₂ aerogel. The high surface area of the support is a critical factor in creating the close contact between

the Cu NPs and the reducing oxide required to stabilize Cu⁰. When the surface area of the support relative to Cu content is lower, either by using a lower surface area support or by increasing Cu loading, the fraction of oxidized Cu is higher, and the Cu SPR is not observed. The consequence of the ability of the CeO₂ morphology to tune activity is seen in the low activity of Cu/CeO₂(partic) for low-temperature CO oxidation. The Cu/CeO₂(aero) catalysts far outperform their Cu/TiO₂(aero) counterparts for low-temperature CO oxidation even at lower Cu weight loadings or equal mole fractions, showing that the transition to the more reducible CeO₂ produces more catalytically active materials. Even with the high surface area CeO₂(aero), in the absence of Cu, low-temperature CO oxidation is not observed. The generalization of the Cu/MOx(aero) motif for stabilizing reduced states of Cu offers a design principle for reactions that benefit from these low-valent states.

4. Experimental

4.1 Materials

Copper(II) nitrate hemipentahydrate (Cu(NO₃)₂·2.5H₂O, Sigma-Aldrich, 98%), cerium chloride heptahydrate (CeCl₃·7H₂O,



Sigma-Aldrich, 99.9%), ($\pm$)-propylene oxide (Sigma-Aldrich, $\geq 99\%$), ceria nanopowder (Sigma-Aldrich, < 50 nm particles, 99.95%, Lot# MKCD8228), ethanol (absolute ethanol, Warner-Graham), and nitric acid (HNO_3 , Fisher 69.9%) were used as received. Methanol (Fisher, 99.9%) for CeO_2 aerogel synthesis was stored over 3 Å sieves and filtered before use. Ultrapure 18 M Ω cm water (Barnstead Micropure) was used in all syntheses requiring water.

4.2 Synthesis of cerium oxide (CeO_2) aerogels

Cerium oxide aerogels were prepared by a modification of a literature procedure.²¹ In a plastic beaker, 2.39 g of $\text{CeCl}_3 \cdot 7\text{H}_2\text{O}$ (6.4 mmol) was dissolved in 10 g of anhydrous MeOH, followed by adding 6 g of propylene oxide while stirring. The solution was allowed to stir until a gel formed and then covered and aged overnight. The aged gel was transferred to a jar, washed several times with isopropanol and then acetone. The wet gels were loaded into a supercritical dryer under acetone, and the acetone was then exchanged for liquid CO_2 at 10 °C over the course of several rinses. The temperature of the dryer was raised to 42 °C, forming a supercritical CO_2 phase and vented slowly to atmospheric pressure. The aerogels were calcined in air at 500 °C (5 °C min⁻¹ ramp, 2 h dwell, 5 °C min⁻¹ cooling ramp) to yield nanocrystalline fluorite CeO_2 aerogel.

4.3 Deposition of Cu nanoparticles at CeO_2 supports

Copper deposition followed a modification of the method used to photodeposit Cu nanoparticles on TiO_2 aerogels.⁶ As an exemplar for 5 wt% Cu loading, a slurry of 100 mg of CeO_2 aerogel or commercial CeO_2 (0.27 mmol) and 19 mg of $\text{Cu}(\text{NO}_3)_2 \cdot 2.5\text{H}_2\text{O}$ (0.08 mmol, 5.2 mg Cu) in 68 mL 9 : 1 H_2O : EtOH in a Pyrex round bottom flask was brought to pH 9.5 $\pm$ 0.5 with aqueous NaOH and HNO_3 . The solution was sparged with Ar for 30 min prior to irradiating the sample with a 500 W Xe arc lamp (Newport-Oriel) for 48 h. The solids were collected by filtration (0.1 μm polyvinylidene fluoride membrane filter), washed with several aliquots of water, air-dried overnight, and then dried at 70 °C for 16 h.

4.4 Structural, physical and chemical characterization

The Brunauer–Emmett–Teller (BET) surface area and Barrett–Joyner–Halenda (BJH) pore size distributions were derived from the desorption arm of the N_2 physisorption isotherms (Micromeritics ASAP2020). The isotherm data were fit with Micromeritics DFTplus software using the Harkins and Jura thickness curve employing the Faas correction. Prior to N_2 physisorption, samples were degassed at 150 °C for 10 h. The crystalline phases were characterized using X-ray diffraction (Rigaku SmartLab, 40 kV and 44 mA, 4° min⁻¹ scan rate). The average crystallite diameter was determined *via* the Scherrer equation using the full width half maximum (FWHM) of the CeO_2 (111) diffraction peak at $2\theta = 28.55^\circ$. Diffuse-reflectance UV-visible spectra (PerkinElmer 750, 60 mm integrating sphere) were converted to absorbance using the Kubelka–Munk transformation. Optical band gaps were determined from Tauc plots by extrapolating the linear portion of the plot near the absorption edge to the energy axis. The X-ray photoelectron spectra (Thermo Scientific

K-Alpha, Al-K α radiation) were recorded using a flood gun to minimize charging on the insulating samples. High-resolution spectra were recorded in the Cu 2p, Ce 3d, and O 1s regions. Peak integration was performed with a Smart background on Advantage software. All peak positions were referenced to the Ce^{4+} 3d_{3/2} shake-up peak at 916.7 eV.²⁸ The scanning electron micrographs were recorded using a LEO Supra 55 field-emission microscope operating at 10 keV in secondary electron mode. Transmission electron microscopy was performed in a JEOL JEM2200FS operating at 200 kV for HR-TEM, preliminary STEM-HAADF, and STEM-EDS while an aberration-corrected STEM Nion UltraSTEM200X operating at 200 kV was used for additional STEM-HAADF, STEM-EELS, and STEM-EDS. Samples of Cu/ CeO_2 were prepared *via* sonication in isopropyl alcohol with dropcasting onto lacey-carbon supports on gold TEM grids.

4.5 Attenuated total reflectance FTIR (ATR)

We prepared suspensions of CeO_2 and Cu/ CeO_2 by sonicating 20 mg of sample in 1.0 mL DI water for 15 min and drop cast 2 μL of each sample onto a ZnSe ATR prism for a loading of 4 mg. To increase wettability of the ZnSe ATR prisms prior to drop casting, we plasma oxidized the clean prism under 310 mTorr and 250 mL min⁻¹ O_2 for 5 min (March Fluorine Reactive Ion Etcher). The ATR spectra were monitored with a Nicolet 6700 (ThermoFisher) equipped with a liquid nitrogen-cooled MCT/B detector. Spectra were taken during the fill as well as purging segments with a resolution of 4 cm⁻¹ in the range of 650–4000 cm⁻¹ as a product of a 32-scan average with no attenuation and an aperture setting to 74%.

The binding of CO on CeO_2 and Cu/ CeO_2 was investigated at room temperature under anaerobic conditions (10 mL min⁻¹ CO, 25 mL min⁻¹ He). The sample was dried overnight under He flow prior to CO exposure. The feed stream flowed over the sample for 10 min to saturate the catalyst surface, then $\text{CO}_{(\text{g})}$ was purged from the system with 25 mL min⁻¹ He for 5 h.

4.6 Carbon monoxide oxidation

Carbon monoxide (CO) oxidation was performed in a glass tube (3/8" OD, 0.22" ID) continuous-flow packed bed reactor (PBR) housed in a programmable ceramic tube oven. Reactions were conducted under dark conditions. The temperature controller (Digi-Sense 1-Zone, Cole Parmer) was interfaced to a K-type thermocouple affixed to the outer wall of the reactor. The temperature differential between the center of the catalyst bed and the outer wall of the reactor is a possible source of error; however, the thin, 0.15", glass-tube reactor wall should not be sufficient to generate a significant temperature gradient. Reaction conditions were chosen such that heat and mass transport effects were inconsequential.^{32,37,38} The 50 mg catalyst bed was sandwiched between glass wool. We diluted 10 mg of Cu/ CeO_2 catalyst with 40 mg of native (*i.e.*, Cu-free) CeO_2 in order to increase space time and limit conversion.

Prior to reaction, the catalyst bed was activated at 150 °C (ramp rate 10 °C min⁻¹, dwell time 30 min) in an anoxic gas stream of 1.25% CO in He (64 mL min⁻¹). These conditions were chosen to minimize ripening, to highlight the ability of the



catalyst to function without high-temperature oxidation and reduction treatments, and to facilitate comparison to earlier work.^{32,35,39} During reaction, the reactor was kept at atmospheric pressure while feeding 80 mL min⁻¹ of 1% CO (Airgas, 10 000 ppm), 20% O₂ (Keen, 4.4 grade, 200 000 ppm), and 79% He (Praxair, 5.0 UHP), giving a GHSV of 39 000 h⁻¹. The temperature was decreased stepwise at a ramp rate of 2 °C min⁻¹. Reactor effluent was fed into an in-line GC (GC-2014, Shimadzu) equipped with a Pulsed Discharge Detector for product analysis. Reaction products were analyzed at steady state by allowing the reactor to dwell at each temperature (150 °C, 125 °C, 100 °C, 90 °C, 80 °C, 70 °C, 60 °C, and 50 °C) for 35 min. The durability and aging of the catalyst was tested *via* four regenerations for a total of 5 cycles.

Conflicts of interest

The authors have no conflicts of interest to declare.

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